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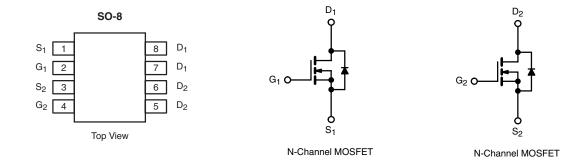
Dual N-Channel 2.5-V (G-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)		
20	0.022 at V_{GS} = 4.5 V	6.6		
	0.030 at V_{GS} = 2.5 V	5.5		

FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFETs





ABSOLUTE MAXIMUM RATINGS $T_A = 25 \degree C$, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	20		V	
Gate-Source Voltage		V _{GS}	± 12			
	T _A = 25 °C	- I _D	6.6	5.2		
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T _A = 70 °C		5.5	3.5		
Pulsed Drain Current		I _{DM}	30		A	
Continuous Source Current (Diode Conduction) ^a		۱ _S	1.5	1.0		
Maximum Power Dissipation ^a	T _A = 25 °C	PD	1.5	1.0	W	
	T _A = 70 °C	ГD	0.96	0.64	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Тур.	Max.	Unit
Maximum haration to Analyticata	t ≤ 10 s	R _{thJA}	72	83	
Maximum Junction-to-Ambient ^a	Steady State		100	120	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	55	70	

Notes:

a. Surface Mounted on FR4 board, $t \leq$ 10 s.

* Pb containing terminations are not RoHS compliant, exemptions may apply.

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static			_				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6		1.6	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 200	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 20 V, V_{GS} = 0 V$			1		
	IDSS	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 70 ^{\circ}\text{C}$			25	μA	
On-State Drain Current ^b	I _{D(on)}	$V_{DS}{\leq}5$ V, $V_{GS}{=}4.5$ V	30			А	
Drain-Source On-State Resistance ^b	Б	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$		0.0165	0.022	0	
	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 5.5 \text{ A}$		0.023	0.030	Ω	
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$		30		S	
Diode Forward Voltage ^b	V _{SD}	$I_{S} = 1.5 \text{ A}, V_{GS} = 0 \text{ V}$		0.71	1.2	V	
Dynamic ^a							
Total Gate Charge	Qg			12	18		
Gate-Source Charge	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 6.5 A		2.2		nC	
Gate-Drain Charge	Q _{gd}			3.6			
Turn-On Delay Time	t _{d(on)}			245	365		
Rise Time	t _r	V_{DD} = 10 V, R_L = 10 Ω		330	495	20	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong\text{1}$ A, V_GEN = 4.5 V, R_G = 6 Ω		860	1300	ns	
Fall Time	t _f			510	765]	

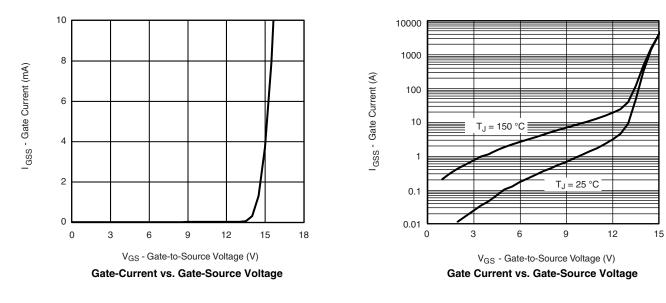
Notes:

a. For design aid only; not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

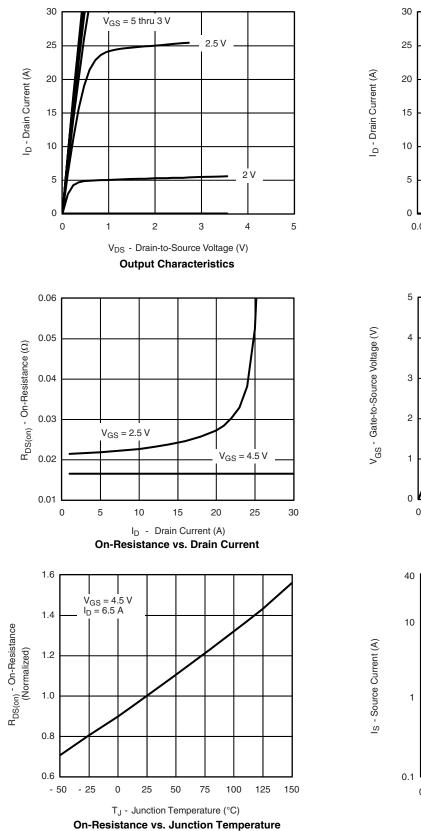


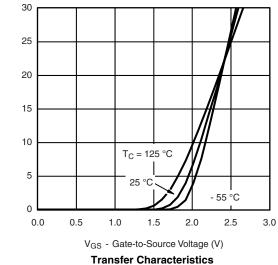


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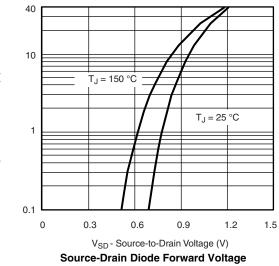






 $V_{DS} = 10 V$ $V_{DS} = 10 V$ $V_{DS} = 6.5 A$ $V_{DS} = 10 V$ $V_{DS} = 0.5 A$ Q_{0} $V_{DS} = 10 V$ $V_{DS} = 10 V$ $V_{DS} = 0.5 A$ $V_{DS} = 0.5 A$ $V_{DS} = 0.5$

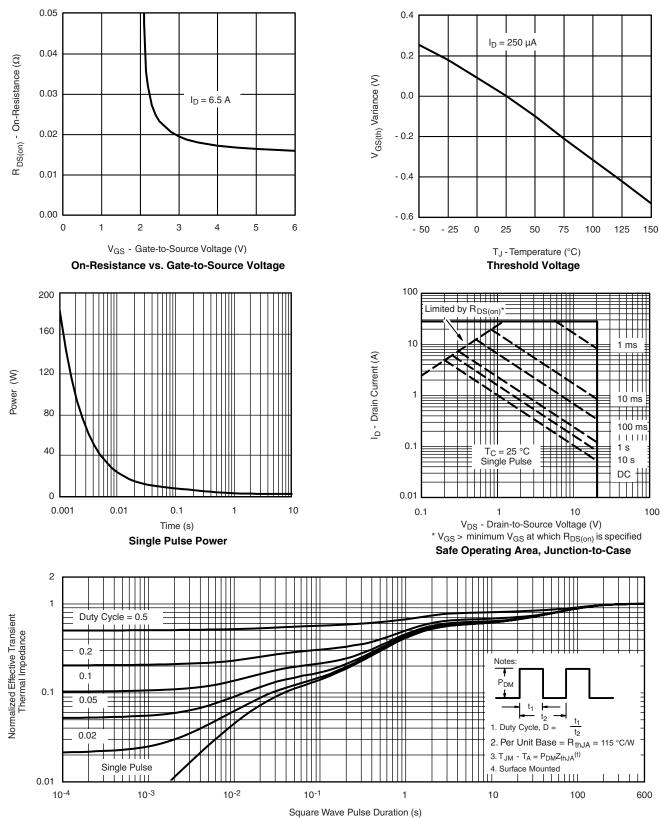
Gate Charge



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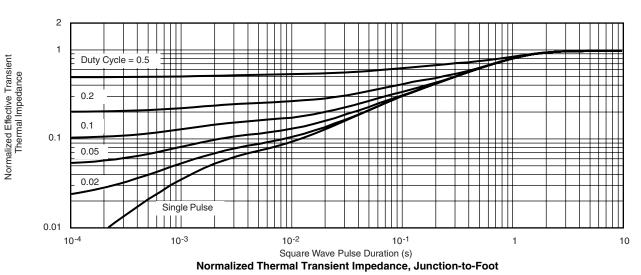


Normalized Thermal Transient Impedance, Junction-to-Ambient



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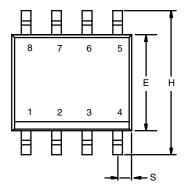


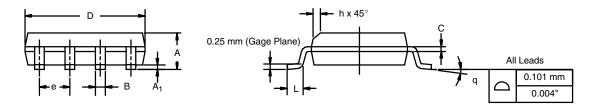


Package Information www.din-tek.jp

SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

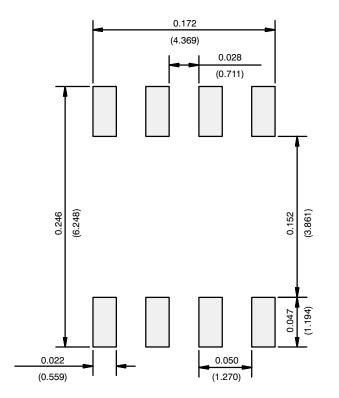




	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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